Small Signal MOSFET

Complementary 20 V, 540 mA / -430 mA, with ESD protection, SOT-563 package.

Features

- Leading Trench Technology for Low RDS(on) Performance
- High Efficiency System Performance
- Low Threshold Voltage
- ESD Protected Gate
- Small Footprint 1.6 x 1.6 mm
- These are Pb-Free Devices

Applications

- DC-DC Conversion Circuits
- Load/Power Switching with Level Shift
- Single or Dual Cell Li-Ion Battery Operated Systems
- High Speed Circuits
- Cell Phones, MP3s, Digital Cameras, and PDAs

MAXIMUM RATINGS (T_J = 25° C unless otherwise specified)

Para	Symbol	Value	Unit			
Drain-to-Source Voltag	V _{DSS}	20	V			
Gate-to-Source Voltag	е		V _{GS}	±6	V	
N-Channel	Steady	$T_A = 25^{\circ}C$		540		
Continuous Drain Current (Note 1)	State	$T_A = 85^{\circ}C$		390		
	$t \le 5 s$	$T_A = 25^{\circ}C$		570		
P-Channel	Steady	$T_A = 25^{\circ}C$	ID	-430	mA	
Continuous Drain Current (Note 1)	State	$T_A = 85^{\circ}C$		-310		
	$t \le 5 s$	$T_A = 25^{\circ}C$		-455		
Power Dissipation (Note 1)	Steady State			250		
	Sidle	$T_A = 25^{\circ}C$	PD		mW	
	$t \le 5 s$			280		
Pulsed Drain Current	N-Channel	t = 10 uc		1500	mA	
	P-Channel	t _p = 10 μs	IDM	-750	ШA	
Operating Junction and	T _J , T _{STG}	-55 to 150	°C			
Source Current (Body I	۱ _S	350	mA			
Lead Temperature for S (1/8" from case for 1	oses	ΤL	260	°C		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 in sq. pad size

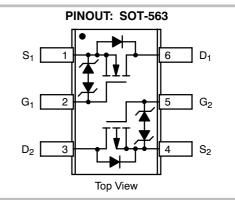
(Cu area = 1.127 in sq [1 oz] including traces).



ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max (Note 1)
N-Channel 20 V	0.4 Ω @ 4.5 V	
	0.5 Ω @ 2.5 V	540 mA
20 1	0.7 Ω @ 1.8 V	
	0.5 Ω @ -4.5 V	
P-Channel -20 V	0.6 Ω @ -2.5 V	-430 mA
	1.0 Ω @ -1.8 V	





ORDERING INFORMATION

Device	Package	Shipping [†]								
NTZD3155CT1G	SOT-563 (Pb-Free)	4000 / Tape & Reel								
NTZD3155CT2G	SOT-563 (Pb-Free)	4000 / Tape & Reel								
NTZD3155CT5G	SOT-563 (Pb-Free)	8000 / Tape & Reel								

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Thermal Resistance Ratings

Parameter	Symbol	Мах	Unit
Junction-to-Ambient – Steady State (Note 2)	$R_{ hetaJA}$	500	°C/W
Junction-to-Ambient $- t = 5 s$ (Note 2)		447	

2. Surface mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	N/P	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	Ν	$V_{GS} = 0 V$	I _D = 250 μA	20			V
		Р		I _D = -250 μA	-20			
Drain-to-Source Breakdown Voltage Temperature Coefficient	V(_{BR)DSS} /T _J			-		18		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	Ν	V_{GS} = 0 V, V_{DS} = 16 V	T _J = 25°C			1.0	μΑ
		Р	$V_{GS} = 0 V, V_{DS} = -16 V$				-1.0	
		Ν	V_{GS} = 0 V, V_{DS} = 16 V	T _J = 125°C			2.0	μΑ
		Р	$V_{GS} = 0 V, V_{DS} = -16V$				-5.0	
Gate-to-Source Leakage Current	I _{GSS}	Р	V_{DS} = 0 V, V_{GS} = ±4.5 V				±2.0	μA
		Ν					± 5.0	

ON CHARACTERISTICS (Note 3)

Gate Threshold Voltage	V _{GS(TH)}	Ν	$V_{GS} = V_{DS}$	I _D = 250 μA	0.45		1.0	V
		Р		I _D = -250 μA	-0.45		-1.0	
Gate Threshold Temperature Coefficient	V _{GS(TH)} /T _J					-1.9		-mV/ °C
Drain-to-Source On Resistance	R _{DS(on)}	Ν	V _{GS} = 4.5 V, I _D =	V_{GS} = 4.5 V, I _D = 540 mA		0.4	0.55	
		Р	V_{GS} = -4.5V, I_{D} = -430 mA			0.5	0.9	
		Ν	V _{GS} = 2.5 V, I _D =	5 V, I _D = 500 mA		0.5	0.7	
		Р	V _{GS} = -2.5V, I _D =		0.6	1.2	Ω	
		Ν	V_{GS} = 1.8 V, I _D = 350 mA			0.7	0.9	
		Р	V _{GS} = -1.8V, I _D =		1.0	2.0		
Forward Transconductance	9fs	Ν	V _{DS} = 10 V, I _D = 540 mA 1.0		1.0		0	
		Р	V _{DS} = -10 V, I _D =	-430 mA		1.0		S

CHARGES, CAPACITANCES AND GATE RESISTANCE

Input Capacitance	C _{ISS}			80	150	
Output Capacitance	C _{OSS}	Ν	f = 1 MHz, V _{GS} = 0 V V _{DS} = 16 V	13	25	
Reverse Transfer Capacitance	C _{RSS}			10	20	- 5
Input Capacitance	C _{ISS}			105	175	pF
Output Capacitance	C _{OSS}	Р	f = 1 MHz, V _{GS} = 0 V V _{DS} = -16 V	15	30	
Reverse Transfer Capacitance	C _{RSS}			10	20	

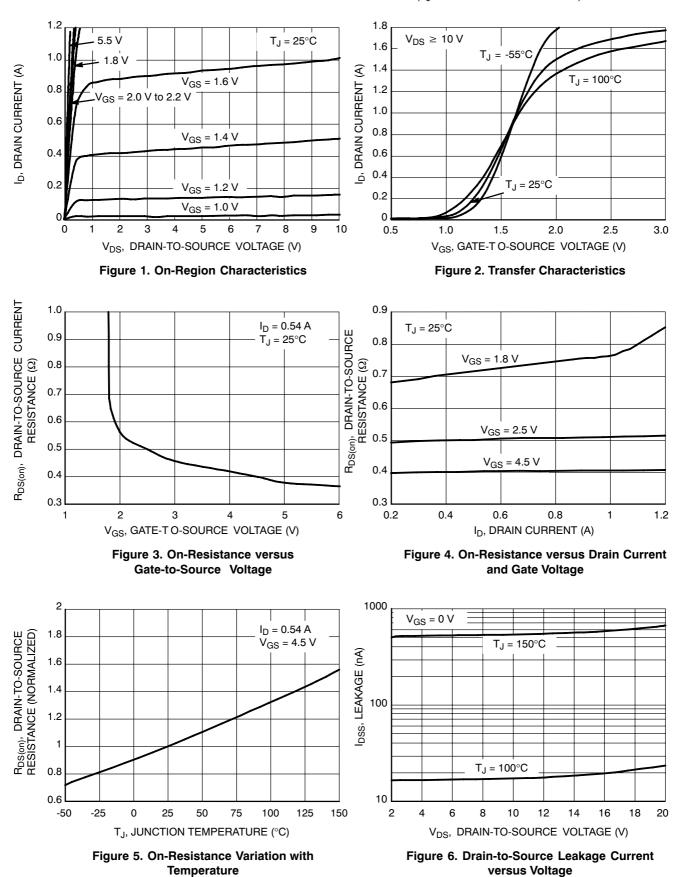
3. Pulse Test: pulse width \leq 300 $\mu s,$ duty cycle \leq 2%

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	N/P	Test Condition	n	Min	Тур	Мах	Unit
CHARGES, CAPACITANCES A	ND GATE RESIST	ANCE						
Total Gate Charge	Q _{G(TOT)}					1.5	2.5	
Threshold Gate Charge	Q _{G(TH)}	N				0.1		
Gate-to-Source Charge	Q _{GS}		V_{GS} = 4.5 V, V_{DS} = -10 V;	I _D = 540 mA		0.2		
Gate-to-Drain Charge	Q _{GD}					0.35		~
Total Gate Charge	Q _{G(TOT)}		V _{GS} = -4.5 V, V _{DS} = 10 V; I _D = -380 mA			1.7	2.5	nC
Threshold Gate Charge	Q _{G(TH)}	Р				0.1		_
Gate-to-Source Charge	Q _{GS}				0.3			
Gate-to-Drain Charge	Q _{GD}					0.4		
SWITCHING CHARACTERISTI	CS (V _{GS} = V) (Not	te 4)				•	•	
Turn-On Delay Time	t _{d(ON)}	Ν			6.0			
Rise Time	t _r		V _{GS} = 4.5 V, V _{DD} = -10 V,	I _D = 540 mA,		4.0		
Turn-Of f Delay Time	t _{d(OFF)}		V_{GS} = 4.5 V, V_{DD} = -10 V, R_{G} = 10 Ω			16		
Fall Time	t _f					8.0		
Turn-On Delay Time	t _{d(ON)}	Р				10		ns
Rise Time	tr		VGS = -4.5 V. Vחס = 10 V. I	Voc4.5 V Voc - 10 V Io215 mA		12		
Turn-Of f Delay Time	t _{d(OFF)}	1	V_{GS} = -4.5 V, V_{DD} = 10 V, I_{D} = -215 mA, R_{G} = 10 Ω			35		
Fall Time	t _f	1				19		
Drain-Source Diode Characte	ristics					•	· •	
Forward Diode Voltage	V _{SD}	Ν	N/ 0.1/ T 0500	I _S = 350 mA		0.7	1.2	.,
		Р	$V_{GS} = 0 V, T_{J} = 25^{\circ}C$	L = 250 mA		0.0	10	V

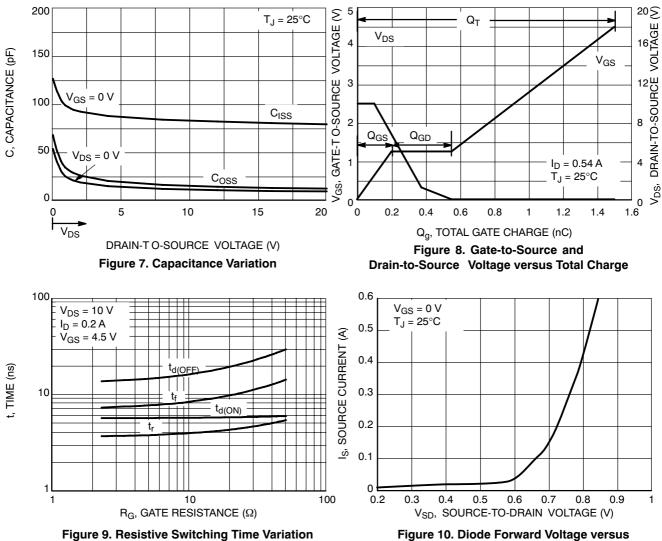
Forward Diode Voltage	V _{SD}	N	V	I _S = 350 mA	0.7	1.2	V
		Р	V_{GS} = 0 V, T_{J} = 25°C	I _S = -350 mA	-0.8	-1.2	v
Reverse Recovery Time	t _{RR}	Ν	V _{GS} = 0 V, dIS/dt = 100 A/μs	I _S = 350 mA	6.5		
		Р	ui3/ut = 100 Α/μs	I _S = -350 mA	13		ns

4. Switching characteristics are independent of operating junction temperatures



N-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

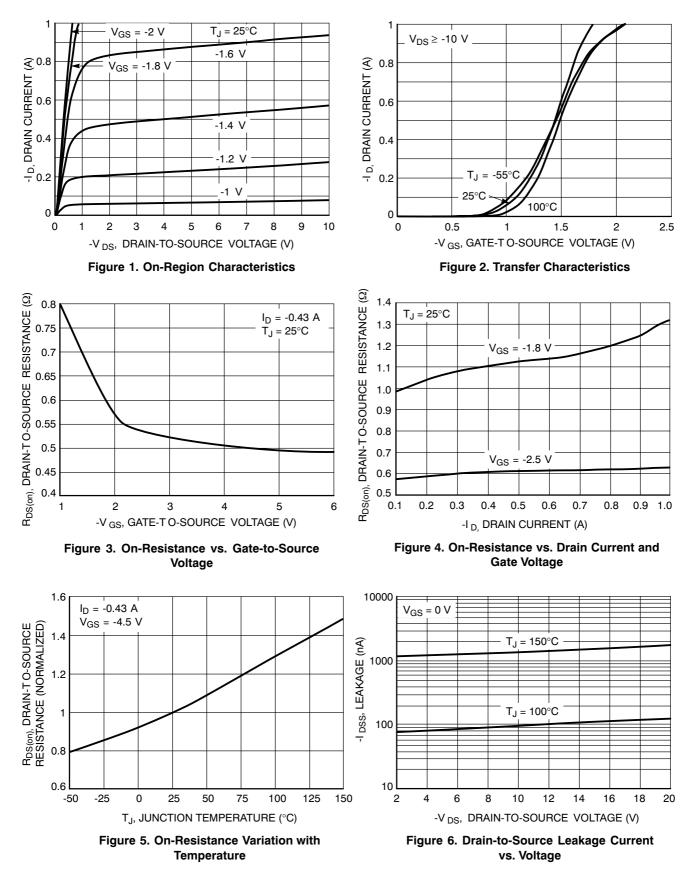
N-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)



versus Gate Resistance

Current

P-CHANNEL TYPICAL PERFORMANCE CURVES ($T_J = 25^{\circ}C$ unless otherwise noted)



P-CHANNEL TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

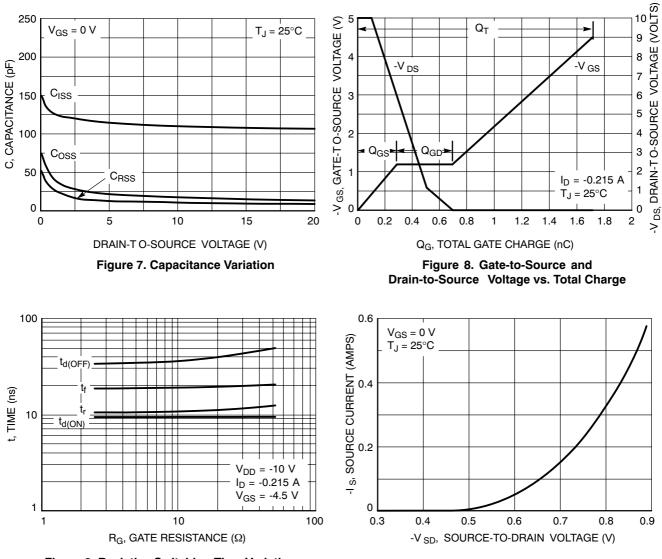


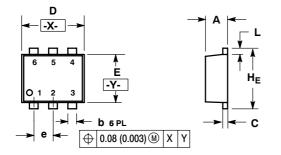
Figure 9. Resistive Switching Time Variation vs. Gate Resistance

Figure 10. Diode Forward Voltage vs. Current

PACKAGE DIMENSIONS

SOT-563, 6 LEAD CASE 463A-01

ISSUE F



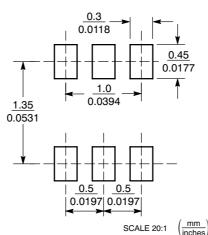
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982

CONTROLLING DIMENSION: MILLIMETERS 2

MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS З. IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MIL	LIMETE	RS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.50	0.55	0.60	0.020	0.021	0.023	
b	0.17	0.22	0.27	0.007	0.009	0.011	
С	0.08	0.12	0.18	0.003	0.005	0.007	
D	1.50	1.60	1.70	0.059	0.062	0.066	
Е	1.10	1.20	1.30	0.043	0.047	0.051	
е		0.5 BSC)	0.02 BSC			
L	0.10	0.20	0.30	0.004	0.008	0.012	
HE	1.50	1.60	1.70	0.059	0.062	0.066	

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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